

SOP-8 N Channel Enhancement 沟道增强型 MOS Field Effect Transistor 场效应管

■Features 特点

Low on-resistance Low Qg 低导通电阻/低栅电荷密度

$R_{DS(ON)}=6.5m\Omega(\text{Type})@V_{GS}=10V$

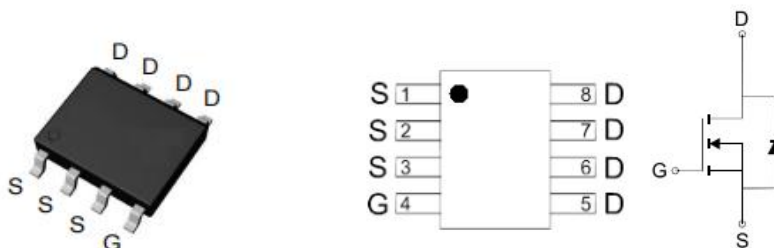
$R_{DS(ON)}=10.5m\Omega(\text{Type})@V_{GS}=4.5V$

■Applications 应用

DC-DC Power System 升压转换

High Frequency Point-of-Load Synchronous Buck Convert 负载点高频同步整流

■Internal Schematic Diagram 内部结构



■Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	30	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 20	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$ at $T_A = 70^\circ C$)	25 15	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	80	A
Total Device Dissipation 总耗散功率	$P_{TOT}(\text{at } T_A = 25^\circ C$ at $T_C = 25^\circ C)$	1.5 3.5	W
Thermal Resistance Junction-A/C 热阻	$R_{\theta JA}$ $R_{\theta JC}$	85 35	$^\circ C/W$
Avalanche Energy Single Pulse 雪崩能量	E_{AS}	105.8	mJ
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ C$

■ Electrical Characteristics 电特性

($T_A=25^{\circ}\text{C}$ unless otherwise noted 如无特殊说明, 温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Type 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压($I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$)	BV_{DSS}	30	—	—	V
Gate Threshold Voltage 栅极开启电压($I_D=250\mu\text{A}$, $V_{GS}=V_{DS}$)	$V_{GS(th)}$	1.0	1.5	2.5	V
Zero Gate Voltage Drain Current 零栅压漏极电流($V_{GS}=0\text{V}$, $V_{DS}=30\text{V}$)	I_{DSS}	—	—	1	μA
Gate Body Leakage 栅极漏电流($V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$)	I_{GSS}	—	—	± 100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻($I_D=20\text{A}$, $V_{GS}=10\text{V}$) ($I_D=11\text{A}$, $V_{GS}=4.5\text{V}$)	$R_{DS(ON)}$	—	6.5 10.5	8 14	$\text{m}\Omega$
Diode Forward Voltage Drop 内附二极管正向压降($I_{SD}=20\text{A}$, $V_{GS}=0\text{V}$)	V_{SD}	—	—	1.2	V
Input Capacitance 输入电容 ($V_{GS}=0\text{V}$, $V_{DS}=15\text{V}$, $f=1\text{MHz}$)	C_{ISS}	—	1700	—	pF
Common Source Output Capacitance 共源输出电容($V_{GS}=0\text{V}$, $V_{DS}=15\text{V}$, $f=1\text{MHz}$)	C_{OSS}	—	320	—	pF
Reverse Transfer Capacitance 反馈电容($V_{GS}=0\text{V}$, $V_{DS}=15\text{V}$, $f=1\text{MHz}$)	C_{RSS}	—	300	—	pF
Total Gate Charge 栅极电荷密度 ($V_{DS}=15\text{V}$, $I_D=10\text{A}$, $V_{GS}=10\text{V}$)	Q_g	—	45	—	nC
Gate Source Charge 栅源电荷密度 ($V_{DS}=15\text{V}$, $I_D=10\text{A}$, $V_{GS}=10\text{V}$)	Q_{gs}	—	3	—	nC
Gate Drain Charge 栅漏电荷密度 ($V_{DS}=15\text{V}$, $I_D=10\text{A}$, $V_{GS}=10\text{V}$)	Q_{gd}	—	15	—	nC
Turn-ON Delay Time 开启延迟时间 ($V_{DS}=15\text{V}$ $I_D=20\text{A}$, $R_{GEN}=3\Omega$, $V_{GS}=10\text{V}$)	$t_{d(on)}$	—	21	—	ns
Turn-ON Rise Time 开启上升时间 ($V_{DS}=15\text{V}$ $I_D=20\text{A}$, $R_{GEN}=3\Omega$, $V_{GS}=10\text{V}$)	t_r	—	32	—	ns
Turn-OFF Delay Time 关断延迟时间 ($V_{DS}=15\text{V}$ $I_D=20\text{A}$, $R_{GEN}=3\Omega$, $V_{GS}=10\text{V}$)	$t_{d(off)}$	—	59	—	ns
Turn-OFF Fall Time 关断下降时间 ($V_{DS}=15\text{V}$ $I_D=20\text{A}$, $R_{GEN}=3\Omega$, $V_{GS}=10\text{V}$)	t_f	—	34	—	ns

■ Typical Characteristic Curve 典型特性曲线

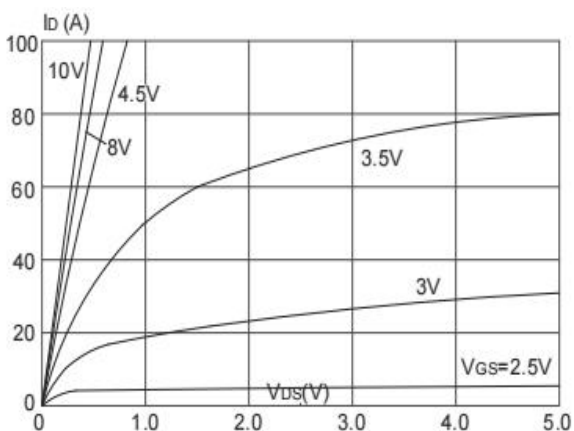


Figure 1: Output Characteristics

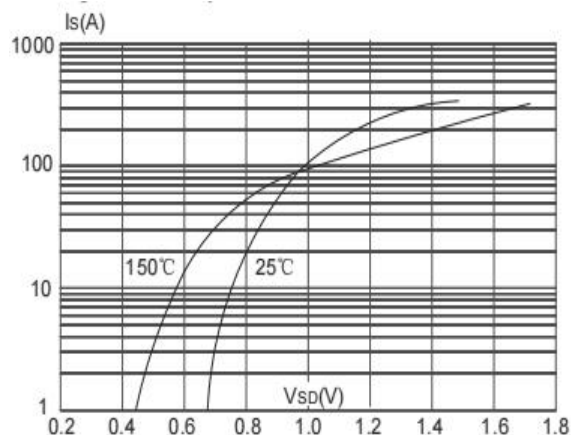


Figure 2: Diode Forward Characteristics

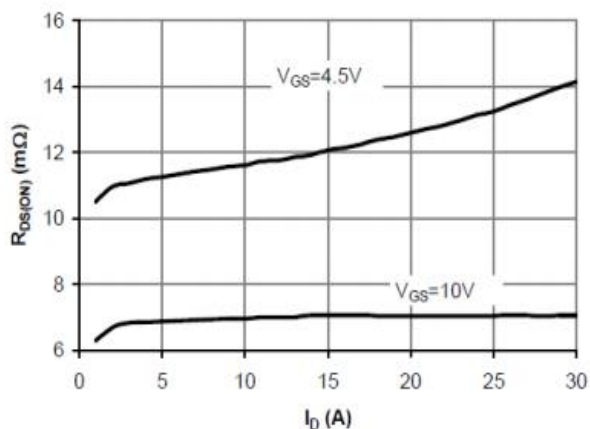


Figure 3: On-Resistance vs. ID

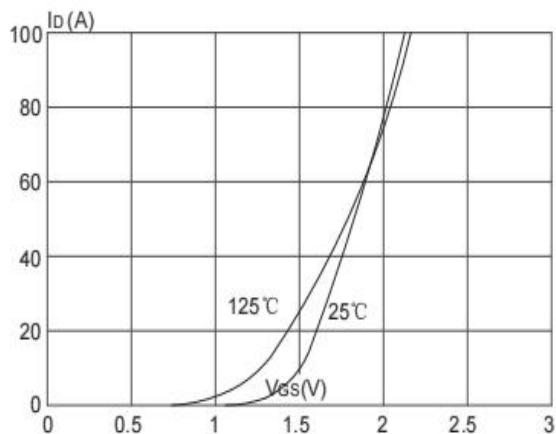


Figure 4: Transfer Characteristics

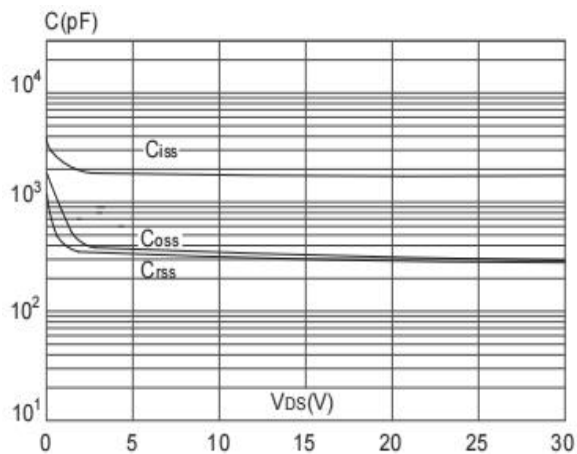


Figure 5: Capacitance Characteristics

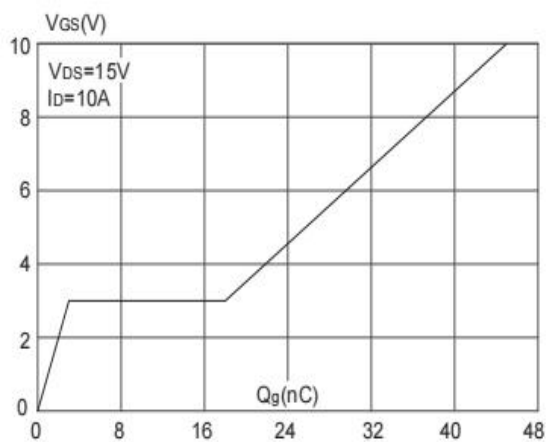


Figure 6: Gate-Charge Characteristics

■ Typical Characteristic Curve 典型特性曲线

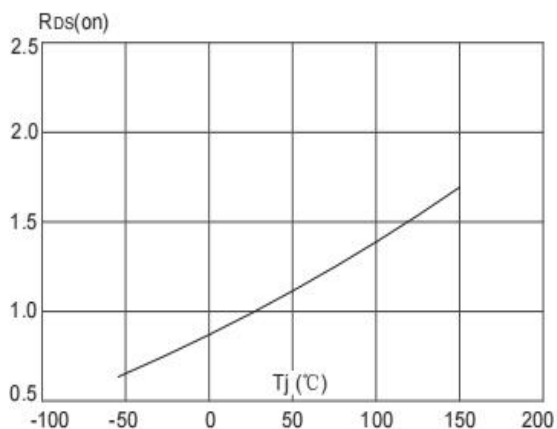


Figure 7: On-Resistance vs. T_J

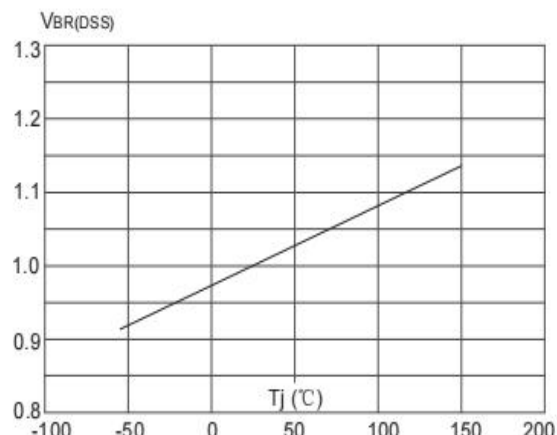


Figure 8: Breakdown Voltage vs. T_J

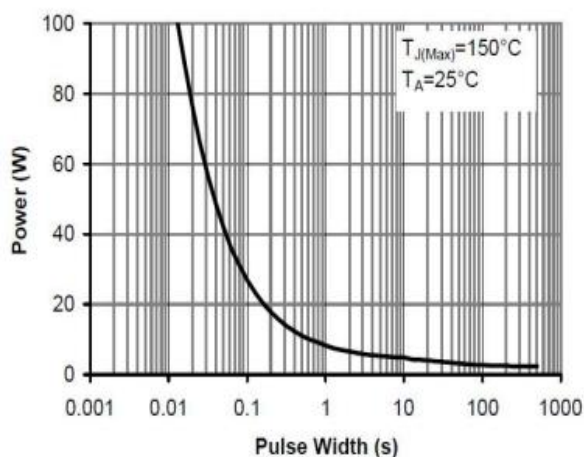


Figure 9: Power Rating Curve

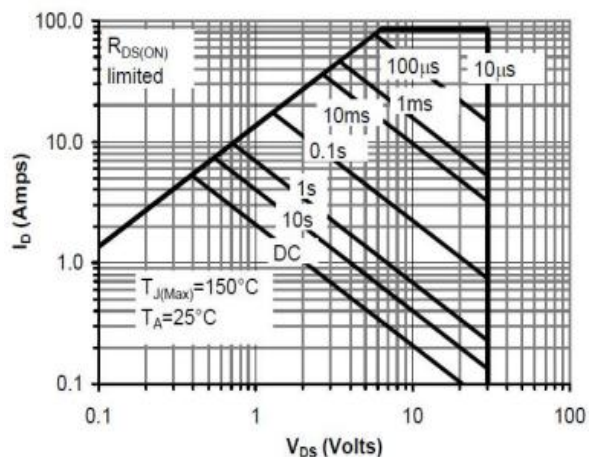


Figure 10: Safe Operating Area

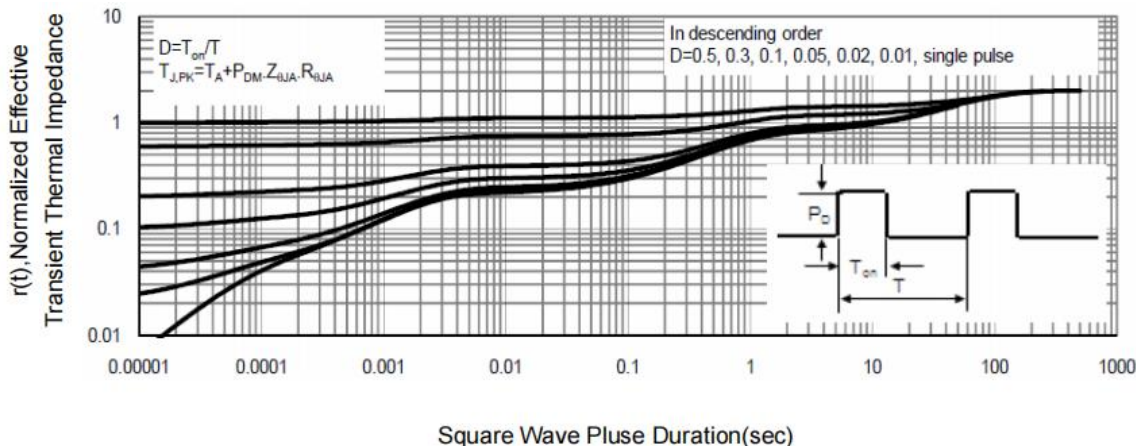
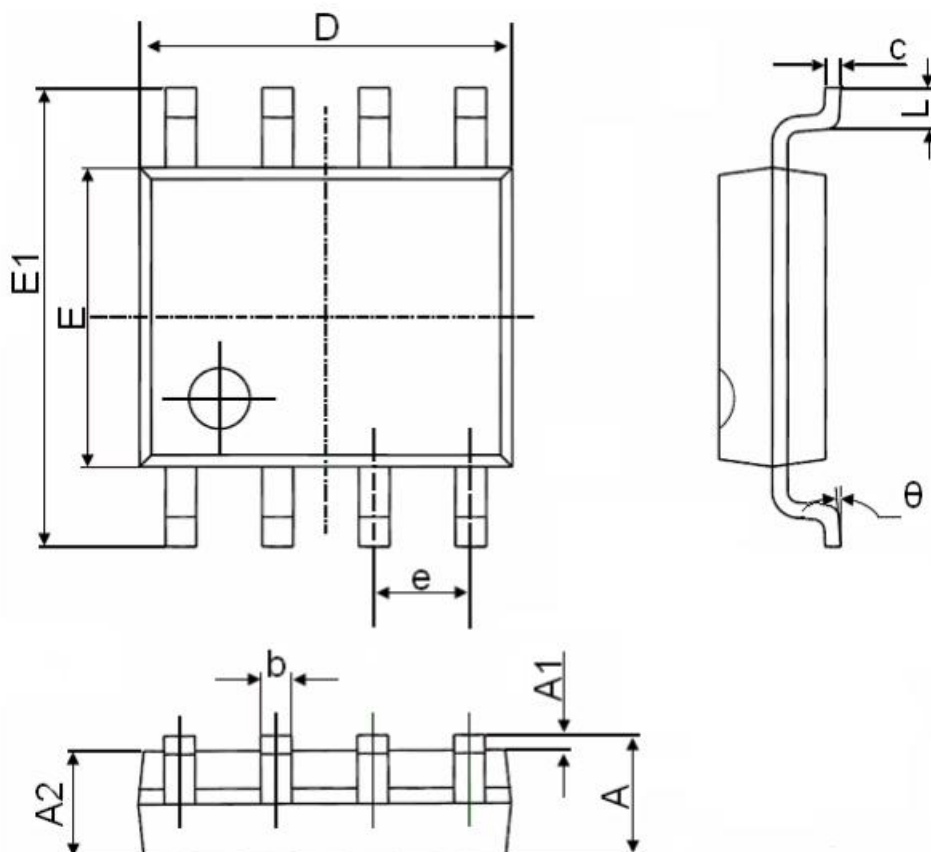


Figure 11: Transient Thermal Response Curve

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°